MX575ABB25M0000

Ultra-Low Jitter 25MHz LVDS XO

ClockWorks® FUSION

General Description

The MX575ABB25M0000 is an ultra-low phase jitter XO with LVDS output optimized for high line rate applications.

Features

- 25MHz LVDS
- Typical phase noise:
  - 151fs (Integration range: 12kHz-5MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 7mm x 5mm LGA package

Absolute Maximum Ratings[1]

Supply Voltage (VIN).....+4.6V
Lead Temperature (soldering, 10s).....260°C
Case Temperature.....115°C
Storage Temperature (T_S).....-65°C to +125°C
ESD Machine Model.....200V
ESD Rating (HBM).....2kV

Operating Ratings[2]

Supply Voltage (VIN).....+2.375V to +3.63V
Ambient Temperature (TA).....-40°C to +85°C
Junction Thermal Resistance
LGA (T_{JC}) Still Air.....53°C/W

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 100Ω between Q and /Q.[3]

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
IDD	Supply Current			90	100	mA
F0	Center Frequency			25		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 5MHz) Integration Range (1.875MHz to 5MHz)		151 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		400	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage VOH max = VCM max + 1/2 VOD max	LVDS output levels	1.248	1.375	1.602	V
VOL	Output Low Voltage VOL min = VCM min - 1/2 VOD max	LVDS output levels	0.898	1.025	1.252	V
VOD	Output Differential Voltage		247	350	454	mV
VCM	Common Mode Output Voltage		1.125	1.2	1.375	V

Notes:

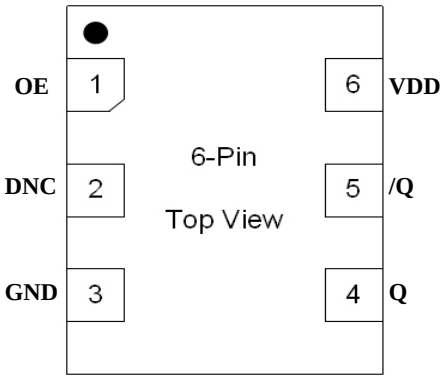
1. Exceeding the absolute maximum ratings may damage the device.
2. The device is not guaranteed to function outside its operating ratings.
3. Guaranteed after thermal equilibrium.
4. Inclusive of initial accuracy, supply voltage, temperature drift, aging (5yrs), shock, vibration.

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX575ABB25M0000	MX575AB	B25M0000	Tube	6-Pin 7mm x 5mm LGA
MX575ABB25M0000-TR	MX575AB	B25M0000	Tape and Reel	6-Pin 7mm x 5mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50kΩ Pull-Up (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVDS	Clock Output Frequency = 25MHz
6	VDD	PWR		Power Supply

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition C
Mechanical Vibration	MIL-STD-883, Method 2007, Condition B
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s
MSL Level	Crystal - MSL-1, Package MSL-3
Solvent Resistance	MIL-STD-202, Method 215

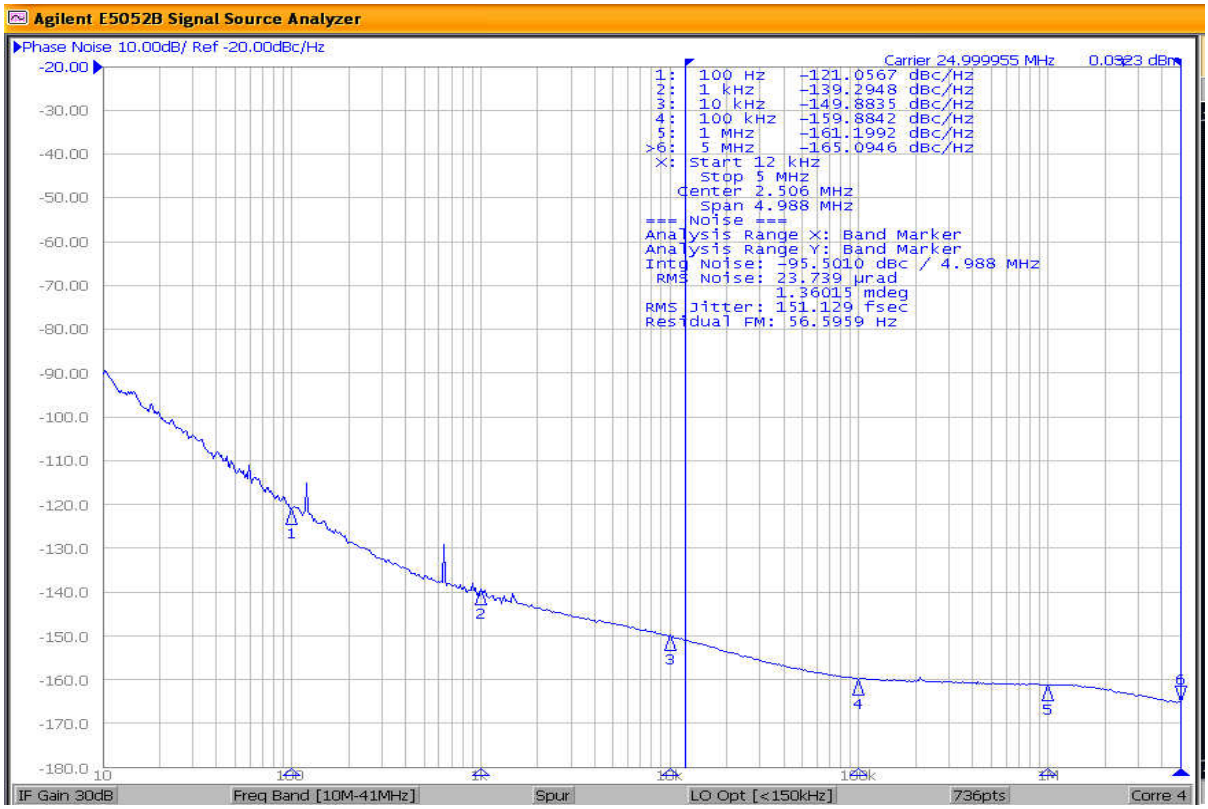
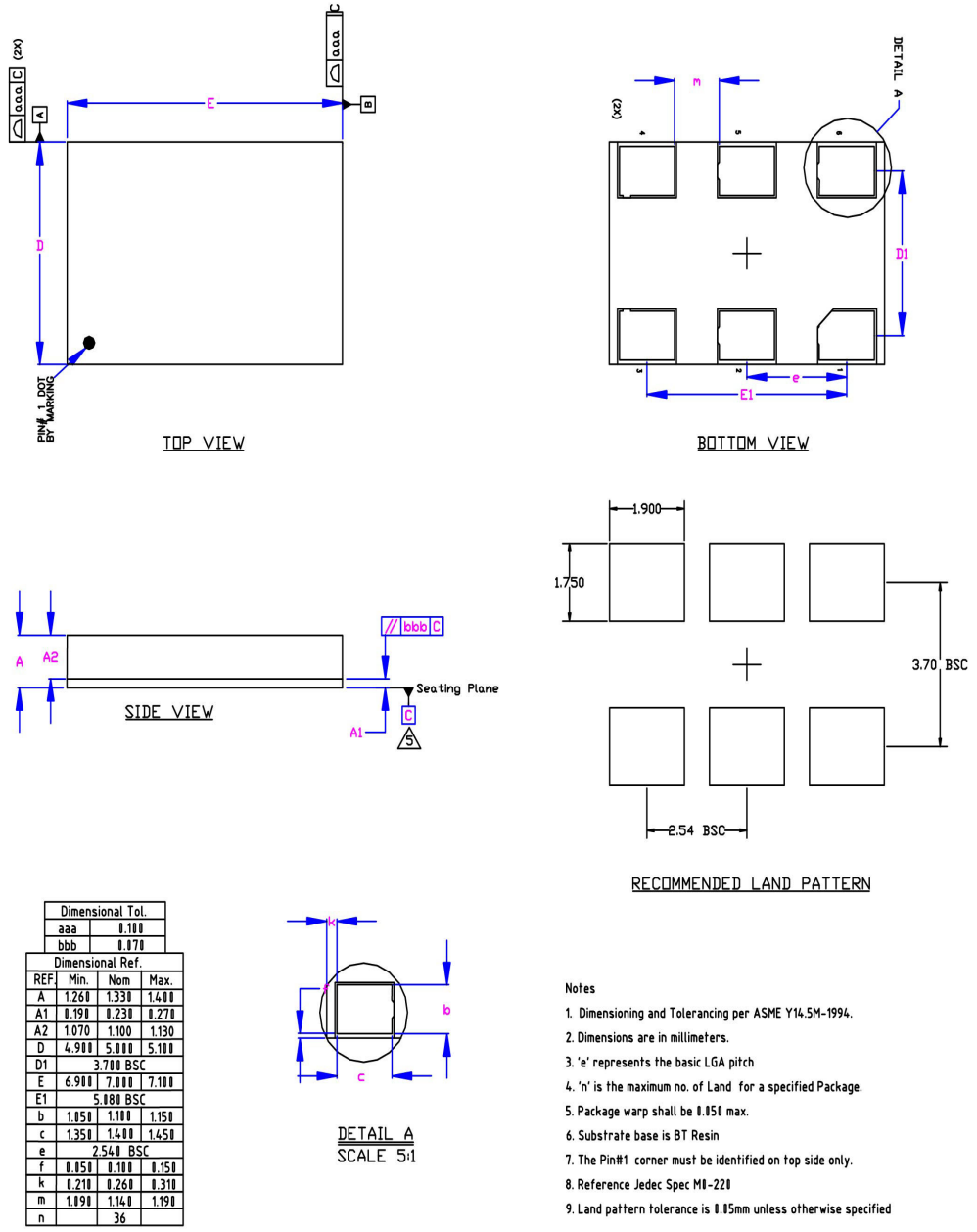


Figure 1. LVDS Output 25MHz 12kHz-5MHz 151fs

Package Information and Recommended Land Pattern for 6-Pin LGA[3]



Dimensional Tol.	
aaa	0.100
bbb	0.070

Dimensional Ref.			
REF.	Min.	Nom	Max.
A	1.260	1.330	1.400
A1	0.190	0.230	0.270
A2	1.070	1.100	1.130
D	4.900	5.000	5.100
D1	3.700 BSC		
E	6.900	7.000	7.100
E1	5.080 BSC		
b	1.050	1.100	1.150
c	1.350	1.400	1.450
e	2.540 BSC		
f	0.050	0.100	0.150
k	0.210	0.260	0.310
m	1.090	1.140	1.190
n		36	

Notes

1. Dimensioning and Tolerancing per ASME Y14.5M-1994.
2. Dimensions are in millimeters.
3. 'e' represents the basic LGA pitch
4. 'n' is the maximum no. of Land for a specified Package.
5. Package warp shall be 0.050 max.
6. Substrate base is BT Resin
7. The Pin#1 corner must be identified on top side only.
8. Reference Jedec Spec MO-220
9. Land pattern tolerance is 0.05mm unless otherwise specified

6-Pin LGA (7x5mm)

Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.